



Call for Papers to the Work in Progress (WiP) Session

related to

[DSD'2024 - the 27th EUROMICRO Conference on Digital Systems Design](#)

and

[SEAA'2024 – the 50th Euromicro Conference on Software Engineering and Advanced Applications](#)

Paris, France, Aug. 28th – Aug. 30th, 2024

Conference web-site and Venue: <https://dsd-seaa.com/venue-and-travel/>

The conference will take place at Sorbonne Université – Campus Pierre et Marie Curie located in the heart of Paris, the Latin Quarter (4 place Jussieu 75005 Paris)..

A Special Session related to DSD'2024 and SEAA'2024 is organized to present WORK in PROGRESS (WiP) in areas related the DSD and SEAA Conferences that is mainly aimed at the research and/or development projects (including Ph.D. and advanced M.Sc. projects) that have not yet attained their final or complete results.

Session Co-Chairs:

- **Radovan Stojanovic**, University of Montenegro, stox@ucg.ac.me
- **Budimir Lutovac**, University of Montenegro, budo@ucg.ac.me
- **Erwin Grosspietsch**, Euromicro, karl-erwin.grosspietsch@online.de
- **Dejan Karadglić**, University of Montenegro, dejank@ucg.ac.me
- **Jovan Đurković**, MECOnet, jovan@meconet.me

Topics of Interest include (but are not limited to) the topics covered by the DSD'2024 and SEAA'2024 Conferences that are listed in the Calls for Papers of the [DSD'2024](#) and [SEAA'2024](#) Conferences and their Special Sessions and can be found at: <https://dsd-seaa.com/dsd2024/> and <https://dsd-seaa.com/seaa2024/>

Submission of Papers: authors intending to participate in the session should submit a short paper (maximum 4 pages) in DOCX ([submission template](#)) via [submission form](#) no later than by 14 July, 2024.

Accepted submissions will be published in a separate "Work in Progress" Proceedings and *WiPiEC Journal*, <http://wipiec.digitalheritage.me/index.php/wipiecjournal> and are to be presented in the session by short presentations of 10 minutes.

Extensive information about the DSD/SEAA2024 Conference Event is available at:
<https://dsd-seaa.com/>

Extensive information about WiP Session are available at:

<https://dsd-seaa.com/wip/>

IMPORTANT DATES

Submission Deadline: 14 July, 2024

Acceptance Notification: 19 July, 2024

Submission Deadline of Camera-Ready Paper: 31 July, 2024

Registration: (after 19 July 2024)

Paper layout according to standard IEEE layout rules: [Paper template for WiP](#)

Further details will be supplied together with the acceptance notification.

Registration fees:

- **Registration: (after 19 July 2024)**
- [Registration fees are available on the following link.](#)